







Model Curriculum

QP Name: Solder Ball Attach Process Engineer

QP Code: ELE/Q0127

QP Version: 2.0

NSQF Level: 5

Model Curriculum Version: 2.0

Electronics Sector Skills Council of India | | 155, 2nd Floor, ESC House, Okhla Industrial Area - Phase 3, New Delhi – 110020







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Training Parameters

Sector	Electronics
Sub-Sector	Semiconductor Components
Occupation	Production- S&C
Country	India
NSQF Level	5
Aligned to NCO/ISCO/ISIC Code	NCO-2015/2144.0101
Minimum Educational Qualification and Experience	Diploma (After 10 (Electronics/ Mechanical)) with 1 Year of Relevant Experience OR 12th grade Pass with 2 Years of Relevant Experience OR 12th grade pass with 1 year NTC/ NAC with 1 Year of Relevant Experience OR Previous relevant Qualification of NSQF Level (4) with 3 Years of Relevant Experience OR 10th grade pass with 4 Years of Relevant Experience
Pre-Requisite License or Training	NA
Minimum Job Entry Age	18 Years
Last Reviewed On	31.03.2022
Next Review Date	31.03.2025
NSQC Approval Date	31.03.2022
QP Version	2.0
Model Curriculum Creation Date	31.03.2022
Model Curriculum Valid Up to Date	31.03.2025
Model Curriculum Version	2.0
Maximum Duration of the Course	780 Hours







Program Overview

This section summarizes the end objectives of the program along with its duration.

Training Outcomes

At the end of the program, the learner should have acquired the listed knowledge and skills:

- Describe the process of Semiconductor Manufacturing, Assembly, Testing & Packaging evaluating customer requirements and computer issues.
- Demonstrate the evaluation process of customer requirements and semiconductors processing.
- Demonstrate the uses of all standards related to Solder Ball Attach Process
- Demonstrate the process of Implementation of all Solder Ball Attach Machine Handling and Processes
- Demonstrate various practices to be followed to maintain health and safety at work.

Compulsory Modules

The table lists the modules and their duration corresponding to the Compulsory NOS of the QP.

NOS and Module Details	Theory Duration	Practical Duration	On-the-Job Training Duration (Mandatory)	On-the-Job Training Duration (Recommended)	Total Duration	
Bridge Module	21:00	39:00	00:00	00:00	60:00	
Module 1: Introduction	21:00	39:00	00:00	00:00	60:00	
ELE/N0144 Define Recipe and Process Parameters	30:00	60:00	30:00	00:00	120:00	
Module 2: Define Recipe and Process Parameters	30:00	60:00	30:00	00:00	120:00	
ELE/N0145 Data Analysis and Yield Improvement	30:00	60:00	60:00	00:00	150:00	
Module 3: Data Analysis and Yield Improvement	30:00	60:00	60:00	00:00	150:00	
ELE/N0146 Solder Ball Attach Design and Verification	60:00	60:00	60:00	00:00	180:00	
Module 4: Solder Ball Attach Design and Verification	60:00	60:00	60:00	00:00	180:00	
ELE/N0147 Purchasing of Tools and Consumable Materials	60:00	60:00	60:00	00:00	180:00	







Module 5: Purchasing of Tools & Consumable Material	60:00	60:00	60:00	00:00	180:00
ELE/N1002 Apply Health and Safety Practices at Workplace	15:00	15:00	00:00	00:00	30:00
Module 6: Apply health and Safety Practices at Workplace	15:00	15:00	00:00	00:00	30:00
DGT/VSQ/N0102- Employability Skills (60 Hours)	24:00	36:00	00:00	00:00	60:00
Module 7: Employability Skills (60 Hours)	24:00	36:00	00:00	00:00	60:00
Total Duration	240:00	330:00	210:00	00:00	780:00







Module Details

Module 1: Introduction Bridge Module

Terminal Outcomes:

• State the role and responsibilities of a Solder Ball Attach

Duration: 21:00	Duration: 39:00
Theory – Key Learning Outcomes	Practical – Key Learning Outcomes
 Describe the size and scope of the electronics industry and its subsectors Discuss the role and responsibilities of a Solder Ball Attach – Process Engineer Describe various employment opportunities for Solder Ball Attach – Process Engineer 	 Knowledge of the complete ESDM Knowledge of the processes involve in the Soldering Understanding of the Soldering work with the Product Knowledge of the Welding and Wafer Dicing
Classroom Aids	
Training Kit - Trainer guide, Presentations, White	board, Marker, projector, laptop
Tools, Equipment and Other Requirements	

Solder Ball Attach Tools







Module 2: Define Recipe and Process Parameters Mapped to ELE/N0144

Terminal Outcomes:

• State the role and responsibilities of a Solder Ball Attach

Practical – Key Learning Outcomes
, ,
 Prepare Process flow with clear specifications like solder pad size, solder material, Solder Paste Type, Solder Ball Diameter and Pitch, Reflow Temperature & Humidity etc Prepare SOP in such a way so that it is more understandable to operators with pictures, visuals, data Charts etc. Prepare quality flow and procedures for New and existing processes Regular inspection of lot data such as yield, failure etc

Solder Ball Attach Tools







Module 3: Data Analysis and Yield Improvement Mapped to ELE/N0145

Terminal Outcomes:

- Describe the process of standard implementations for Data Analysis and Yield Improvement
- Demonstrate the process of verification all Parameters

Duration: 30:00	Duration: 60:00 Practical – Key Learning Outcomes		
Theory – Key Learning Outcomes			
 Define all package outlines drawings with specifications 	 Data Analysis using statistical methods 		
 Define sample size for each lot to measure all dimensions 	List down/record all failures along with actions to avoid future failure		
After Collecting Data, do statistics	• Train Operators on SOP Flow		
analysis if it is within specification release the lot to next step	 Knowledge of doing some manual testing 		
 Production Yield data collection for each Wafer Lot 	Good understanding of Auto CAD generated designs		
 Any failure at Solder Ball Attach should be passed through failure analysis 	 Any failure at Solder Ball Attach should be passed through failure analysis 		
 Understanding of working principal of machines to improve UPH 			
Classroom Aids			

Tools, Equipment and Other Requirements

Data Analysis Standard's and Procedure's







Module 4: Solder Ball Attach Design and Verification Mapped to ELE/N0146

Terminal Outcomes:

- Describe the process of Design Creation and Verification.
- Demonstrate the process of Verification
- Demonstrate the process of cost and Productivity Improvement

Duration: 60:00	Duration: 60:00
Theory – Key Learning Outcomes	Practical – Key Learning Outcomes
 Auto CAD or equivalent design tool knowledge Knowledge of JEDEC Standard Knowledge of Semiconductor Material Used in Wafer Fabrication Knowledge of wafer fabrication process Understanding of Critical and Normal dimensions Requirements that meet customer's final product specification 	 Practical – Key Learning Outcomes Participate in substrate drawing activities for Solder ball dimensions How to read customer POD, SOD, Wafer Mapping etc Selection of stencil as per Strip outline drawing & Material Responsibility of Verifying package drawing for solder ball Support Design team to create an Optimized Product
 Responsibility of Verifying tray drawing 	
 Responsibility of Verifying scrub/street width profile 	
 Responsibility of Verifying package drawing for solder ball 	
Classroom Aids	
Training kit (Trainer guide, Presentations), White	ehoard Marker projector lanton

Training kit (Trainer guide, Presentations). Whiteboard, Marker, projector, laptop

Tools, Equipment and Other Requirements

Design Creation and Verification Software's







Module 5: Purchasing of Tools and Consumable Materials *Mapped to ELE/N0147*

Terminal Outcomes:

- Knowledge about all tools and equipment's useful Which are required for The Solder Ball Attach
- Knowledge about all tools and equipment's useful for Solder Ball Attach and to implement Quality Standards

Duration: 60:00	Duration: 60:00
Theory – Key Learning Outcomes	Practical – Key Learning Outcomes
 List of Machines & Tools required for process of Die Attach & Wire Bond FAT Report Creation Awareness on general Machine Specification like Operation, Controller, Panel etc Knowledge of characterization phase, feasibility phase, customer samples phase and qualification phase is must Collection of all the quality and realibity data for each characterization, feasibility and qualification build 	 Demonstrate the generation of PCN Process of preparation of Solid Reports Description on All equipment consumables specifications, dimensions and other parameters should be clearly defined by process and equipment engineer General Machine Specification (Operation, Main Controller, Main Panel should function as per requirements given to manufacturer)
Classroom Aids	
Training kit (Trainer guide, Presentations)	
Tools, Equipment and Other Requirements	
Equipment's related to Solder Ball Attach	







Module 6: Apply work and health safety practices *Mapped to ELE/N1002*

Terminal Outcomes:

• Apply health and safety practices at the workplace.

Duration: 30:00	Duration: 30:00			
Theory – Key Learning Outcomes	Practical – Key Learning Outcomes			
 Discuss job-site hazards, risks and accidents. Explain the organizational safety procedures for maintaining electrical safety, handling tools and hazardous materials. Elaborate the electronic waste disposal procedures. Describe the process of disposal of hazardous waste List the name and location of concerned people, documents and equipment for maintaining health and safety in the workplace. Describe how to interpret warning signs while accessing sensitive work areas. Explain the importance of good housekeeping. Describe the importance of maintaining appropriate postures while lifting heavy objects. List the types of fire and fire extinguishers. Explain the importance of efficient utilisation of water, electricity and other resources. List the common sources of pollution and ways to minimize it. Describe the concept of waste management and methods of disposing hazardous waste. Explain various warning and safety signs. Describe different ways of preventing accidents at the workplace. 	 Demonstrate the use of protective equipment suitable as per tasks and work conditions. Report any abnormal situation/behaviour of any equipment/system to the relevant authorities. Administer first aid in case of a minor accident. Demonstrate the steps to free a person from electrocution safely. Administer Cardiopulmonary Resuscitation (CPR). Demonstrate the application of defined emergency procedures such as raising alarm, safe/efficient, evacuation, moving injured people, etc. Prepare a sample incident report. Use a fire extinguisher in case of a fire incident. Demonstrate the correct method of lifting and handling heavy objects. 			
Training kit (Trainer guide, Presentations)				

Training kit (Trainer guide, Presentations)

Tools, Equipment and Other Requirements







Personal Protection Equipment: safety glasses, head protection, rubber gloves, safety footwear, warning signs and tapes, fire extinguisher, first aid kit, fire extinguishers and warning signs.







Module 7: Employability Skills (60 Hours) Mapped to DGT/VSQ/N0102

Terminal Outcomes:

- Discuss about Employability Skills in meeting the job requirements
- Describe opportunities as an entrepreneur.
- Describe ways of preparing for apprenticeship & Jobs appropriately.

Duration: 24:00	Duration: 36:00
Theory – Key Learning Outcomes	Practical – Key Learning Outcomes
 Explain constitutional values, civic rights, responsibility towards society to become a responsible citizen 	 List different learning and employability related GOI and private portals and their usage
 Discuss 21st century skills Explain use of basic English phrases and sentences. 	 Show how to practice different environmentally sustainable practices.
 Demonstrate how to communicate in a well-behaved manner 	 Exhibit 21st century skills like Self- Awareness, Behavior Skills, time management, etc.
 Demonstrate how to work with others 	 Show how to use basic English sentences for everyday conversation
 Demonstrate how to operate digital devices 	 in different contexts, in person and over the telephone Demonstrate how to communicate in
 Discuss the significance of Internet and Computer/ Laptops 	a well -mannered way with others.
 Discuss the need for identifying business opportunities 	Demonstrate how to communicate effectively using verbal and nonverbal
• Discuss about types of customers.	 communication etiquette Utilize virtual collaboration tools to
Discuss on creation of biodata	workeffectively
 Discuss about apprenticeship and opportunities related to it. 	 Demonstrate how to maintain hygiene and dressing appropriately.
	Perform a mock interview
Classroom Aids	

Tools, Equipment and Other Requirements

Computer, UPS, Scanner, Computer Tables, LCD Projector, Computer Chairs, White Board OR

Computer Lab







Module 8: On-the-Job Training Mapped to Solder Ball Attach – Process Engineer

Recommended Duration: 210:00 Mandatory Duration: 00:00

Location: On Site

Terminal Outcomes

- 1. Explain the functions of a Saw Singulation in Semiconductors.
- 2. List the preliminary tasks involved in the repair and maintenance of a Tools and Equipment's
- 3. Demonstrate how to perform preliminary checks on a computer and its peripherals.
- 4. Perform steps to inspect the computer and its peripherals to identify defective modules/components.
- 5. Perform repair and maintenance activities as per the Service Level Agreement (SLA).
- 6. Perform steps to test the functioning of Saw Singulation.
- 7. Communicate product and service-related information to the customer.
- 8. Employ appropriate practices to interact and coordinate with supervisor and colleagues.
- 9. Perform assigned work within the turnaround time and as per the defined quality standards.
- 10. Demonstrate how to maintain a healthy, safe and secure working environment.







Annexure

Trainer Requirements

	Trainer Prerequisites						
Minimum Educational	Specialization	Relevant Industry Experience		Training Experience		Remarks	
Qualification		Years	Specialization	Years	Specialization		
Diploma/ Degree/ ITI/ Certified in relevant CITS Trade	(Electrical/Electronics / Mechanical)	2	Assembly & Packaging	1	Electronics		

Trainer Certification				
Domain Certification	Platform Certification			
"Solar Ball Attach Process Engineer, ELE/Q0127,	Recommended that the Trainer is certified			
version 2.0". Minimum accepted score is 80%.	for the Solder Ball Attach – Process			
	Engineer "Trainer (VET and Skills)", mapped			
	to the Qualification Pack: "MEP/Q2601,			
	V2.0", with minimum score of 80%			







Assessor Requirements

Minimum Specialization Educational Qualification	Specialization	Relevant Industry Experience		Training/Assessment Experience		Remarks
	Years	Specialization	Years	Specialization		
Diploma/ Degree/ ITI/ Certified in relevant CITS Trade	(Electrical/Electronics / Mechanical)	3	Assembly & Packaging	1	Electronics	

Assessor Certification				
Domain Certification	Platform Certification			
"Solar Ball Attach Process Engineer, ELE/Q0127, version 2.0". Minimum accepted score is 80%.	Recommended that the Assessor is certified for the Solder Ball Attach – Process Engineer "Assessor (VET and Skills)", mapped to the Qualification Pack: "MEP/Q2701, V2.0", with minimum score of 80%			







Assessment Strategy

- 1. Assessment System Overview:
 - Batches assigned to the assessment agencies for conducting the assessment on SDMS/SIP or email
 - Assessment agencies send the assessment confirmation to VTP/TC looping SSC
 - The assessment agency deploys the ToA certified Assessor for executing the assessment
 - SSC monitors the assessment process & records
- 2. Testing Environment

To ensure a conducive environment for conducting a test, the trainer will:

- Confirm that the centre is available at the same address as mentioned on SDMS or SIP
- Check the duration of the training.
- Check the Assessment Start and End time to be 10 a.m. and 5 p.m. respectively
- Ensure there are 2 Assessors if the batch size is more than 30.
- Check that the allotted time to the candidates to complete Theory & Practical Assessment is correct.
- Check the mode of assessment—Online (TAB/Computer) or Offline (OMR/PP).
- Confirm the number of TABs on the ground are correct to execute the Assessment smoothly.
- Check the availability of the Lab Equipment for the particular Job Role.
- 3. Assessment Quality Assurance levels / Framework:
 - Question papers created by the Subject Matter Experts (SME)
 - Question papers created by the SME verified by the other subject Matter Experts
 - Questions are mapped with NOS and PC
 - Question papers are prepared considering that level 1 to 3 are for the unskilled & semiskilled individuals, and level 4 and above are for the skilled, supervisor & higher management
 - The assessor must be ToA certified and the trainer must be ToT Certified
 - The assessment agency must follow the assessment guidelines to conduct the assessment
- 4. Types of evidence or evidence-gathering protocol:
 - Time-stamped & geotagged reporting of the assessor from assessment location
 - Centre photographs with signboards and scheme-specific branding
 - Biometric or manual attendance sheet (stamped by TP) of the trainees during the training period
 - Time-stamped & geotagged assessment (Theory + Viva + Practical) photographs & videos
- 5. Method of verification or validation:

To verify the details submitted by the training centre, the assessor will undertake:

- A surprise visit to the assessment location
- A random audit of the batch
- A random audit of any candidate
- 6. Method for assessment documentation, archiving, and access

To protect the assessment papers and information, the assessor will ensure:

- Hard copies of the documents are stored
- Soft copies of the documents & photographs of the assessment are uploaded / accessed from Cloud Storage







Soft copies of the documents & photographs of the assessment are stored on the Hard drive







References

Glossary

Term	Description
Declarative knowledge	Declarative knowledge refers to facts, concepts and principles that need to be known and/or understood in order to accomplish a task or to solve a problem.
Key Learning	Key learning outcome is the statement of what a learner needs to know, understand and be able to do in order to achieve the terminal outcomes. A set of key learning outcomes will make up the training outcomes. Training outcome is specified in terms of knowledge, understanding (theory) and skills (practical application).
OJT (M)	On-the-job training (Mandatory); trainees are mandated to complete specified hours of training on site
OJT (R)	On-the-job training (Recommended); trainees are recommended the specified hours of training on site
Procedural Knowledge	Procedural knowledge addresses how to do something, or how to perform a
Training Outcome	Training outcome is a statement of what a learner will know, understand and be able to do upon the completion of the training .
Terminal Outcome	Terminal outcome is a statement of what a learner will know, understand and be able to do upon the completion of a module. A set of terminal outcomes help to achieve the training outcome.







Acronyms and Abbreviations

Term	Description
DC	Direct Current
ISO	International Organization for Standardization
NCO	National Occupational Standards
NOS	National Skills Qualification Committee
NSQF	National Skills Qualification Framework
OJT	On-the-Job Training
OMR	Optical Mark Recognition
PC	Performance Criteria
PwD	Persons with Disabilities
QP	Qualification Pack
SDMS	Skill Development & Management System
SIP	Skill India Portal
SME	Small and Medium Enterprises
SOP	Standard Operating Procedure
SSC	Sector Skill Council
тс	Trainer Certificate
ТоА	Training of Assessors
ТоТ	Training of Trainers
TP	Training Provider